No.: RMCH-K-HTS-0002 /2

Date: 2024.12.11

# Data sheet

Title: FIXED THICK FILM CHIP RESISTORS;

**RECTANGULAR TYPE & HIGH POWER** 

Style: RMCH06,10,16,20,32,35

AEC-Q200 qualified

RoHS COMPLIANCE ITEM
Halogen and Antimony Free

Note: •Stock conditions

Temperature:  $+5^{\circ}\text{C} \sim +35^{\circ}\text{C}$ Relative humidity:  $25\% \sim 75\%$ 

The period of guarantee: Within 2 year from shipment by the company. Solderability shall be satisfied.

- •Product specification contained in this data sheet are subject to change at any time without notice
- •If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

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#### 1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & high power, style of RMCH06,10,16,20,32,35.

#### 1.2 Applicable documents

JIS C 5201-1: 2011, IEC60115-1: 2008, AEC-Q200 Rev.D

#### 2. Classification

Type designation shall be the following form.

(Example)

1)	RMCH	16	K	123	J	TP
	1	2	3	4	5	6
	Style	е				

1 Fixed thick film chip resistors; rectangular type & high power

— Style

2 Rated dissipation and / or dimension

3 Temperature coefficient of resistance

K	±100×10 <sup>-6</sup> / °C	
–(Dash)	Standard	

# 4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
		1022> 10.2kΩ

#### 5 Tolerance on rated resistance

D	±0.5%	
F	±1%	
J	±5%	

### 6 Packaging form

PA	Press pocket taping	
TH	Departaning	
TP	Paper taping	
TE	Embossed taping	



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#### 3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Style	Rated dissipation (W)		ture coefficient of ance (10°/°C)	Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance
			±200	10~1M	E24, 96	D(+0 E0(-) E(+10(-)
RMCH06	0.063	Standard	+350~-100	1~9.76	E24, 90	D(±0.5%),F(±1%)
TAVICTIO	0.003	Stariuaru	±200	10~1M	E24	J(±5%)
			+350~-100	1~9.1	LZ4	J(±J70)
		K	±100	10~1M	E24, 96	D(±0.5%),F(±1%)
RMCH10	0.125	Standard	±200	1~9.76	<b>∠24</b> , 90	D(±0.570),F(±170)
RIVICITIO	0.123	K	±100	10~1M	E24	1/+50/\
		Standard	±200	1~9.1	C2 <del>4</del>	J(±5%)
	0.25	K	±100	10~1M	E24, 96 E24	D(±0.5%),F(±1%)
RMCH16		Standard	±200	1~9.76		
RIVICITIO		K	±100	10~1M		J(±5%)
		Standard	±200	1~9.1		
	0.4	K	±100	10~1M	E24, 96	D(±0.5%),F(±1%)
RMCH20		Standard	±200	1~9.76		
TAIVICI 120		K	±100	10~1M	E24	1/+50/\
		Standard	±200	1~9.1	C2 <del>4</del>	J(±5%)
	2 0.5	K	±100	10~1M	E24, 96	D(+0.50/.) E(+40/.)
RMCH32		Standard	±200	1~9.76	Ľ24, 90	D(±0.5%),F(±1%)
RIVICI 132		K	±100	10~1M	E24	1/+50/\
		Standard	±200	1~9.1	⊏24	J(±5%)
	K Standard	K	±100	10~1M	F24.00 P(10.50() F(14	D(±0.5%) E(±1%)
RMCH35		±200	1~9.76	E24, 96	D(±0.5%),F(±1%)	
KIVICH33	0.75	K	±200	10~1M	E24	1/+50/>
		Standard	±200	1~9.1		J(±5%)

Style	Limiting element voltage (V)	Insulation voltage (V)	Category temperature range (°C)
RMCH06	25	50	
RMCH10	50	100	
RMCH16	150	150	<i>–</i> 55∼+155
RMCH20			-55~±155
RMCH32	200	500	
RMCH35			

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#### 3.2 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

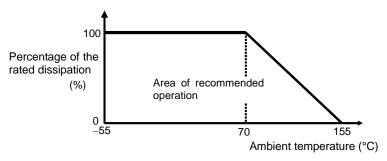


Figure-1 Derating curve

#### 3.3 Rated voltage

d.c. or a.c. r.m.s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E: Rated voltage (V)

P: Rated dissipation (W)

R: Rated resistance  $(\Omega)$ 

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

#### 4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Packaging form		Standard packaging quantity / units	Application
PA	Press pocket taping (paper taping)	8mm width, 2mm pitches	15,000 pcs.	RMCH06
TH	Paper taping	8mm width, 2mm pitches	10,000 pcs.	RMCH10
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RMCH16,20,32
TE	Embossed taping	8mm width, 4mm pitches	4,000 pcs.	RMCH35

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#### 5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

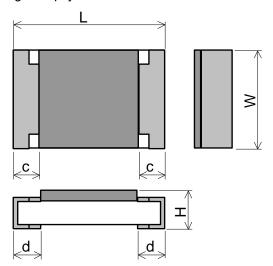


Figure-2

Table-3 Unit: mm W Style Н d С RMCH06  $0.6 \pm 0.03$  $0.3 \pm 0.03$ 0.23±0.03 0.1±0.15 0.15±0.05  $0.25^{+0.05}_{-0.10}$ RMCH10 1.0±0.05 0.5±0.05 0.35±0.05 0.2±0.15 RMCH16 1.6±0.1  $0.8^{+0.15}_{-0.05}$ 0.45±0.10 0.3±0.2 0.3±0.1 RMCH20 2.0±0.1 1.25±0.10 0.55±0.10  $0.3 \pm 0.2$  $0.4 \pm 0.2$ RMCH32 3.1±0.1 1.6±0.15 0.55±0.10 0.3±0.2 0.5±0.25 RMCH35 3.1±0.15 2.5±0.15 0.55±0.15  $0.3 \pm 0.2$ 0.5±0.25

#### 5.2 Net weight (Reference)

Style	Net weight(mg)
RMCH06	0.16
RMCH10	0.6
RMCH16	2
RMCH20	5
RMCH32	9
RMCH35	16

#### 6. Marking

The Rated resistance of RMCH06,10 should not be marked.

The nominal resistance shall be marked in 3 digits or 4 digits and marked on over coat side.

• E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

The Rated resistance of RMCH16 should not be marked in 4 digits (E96).

		3 ( /	
Marking example	Contents	Application	
123	12×10 <sup>3</sup> $[\Omega] \rightarrow$ 12 $[k\Omega]$	RMCH16,20,32,35	
2R2	2.2 [Ω]	Less than 10Ω of RMCH16,20,32,35	
5623	$562\times10^{3} [\Omega] \rightarrow 562[k\Omega]$	RMCH20,32,35	
12R7	12.7 [Ω]	RMCH20,32,35	

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#### 7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1:2011.

7.2 The performance shall be satisfied in Table-4.

Table 4(1)

	T ("	Iable_4(1)	
No.	Test items	Condition of test	Performance requirements
1	High temperature exposure	MIL-STD-202 Method 108	RMCH06: $\Delta$ R/R: Within $\pm$ (3%+0.1 $\Omega$ )
	AEC Q200 - No.3	Ambient temperature:155±2°C,	Other: $\Delta$ R/R: Within $\pm$ (2%+0.1 $\Omega$ )
		Condition: Without load,	
		Duration: 1000 +48 h	No visible damage
		Interval measurements: 250 h and 500 h	
2	Temperature cycling	JESD22 Method JA-104	RMCH06: $\Delta$ R/R: Within $\pm$ (3%+0.1 $\Omega$ )
	AEC Q200 - No.4	Temperature: -55±3°C / 125±2°C,	Other: $\Delta$ R/R: Within $\pm$ (1%+0.05 $\Omega$ )
		Dwell time: 30min maximum at each temp.	
		Transition time: 1 min. max.	No visible damage
		Number of cycles: 1000 cycles.	
3	Bias humidity	Interval measurements: 250 cy and 500 cy MIL-STD-202 Method 103	PMCH06: AP/P: Within ±(39/±0.10)
	AEC Q200 – No.7	Condition: 85°C & 85% R.H.	RMCH06: $\Delta$ R/R: Within $\pm$ (3%+0.1 $\Omega$ ) Other: $\Delta$ R/R: Within $\pm$ (2%+0.1 $\Omega$ )
	110 9200 110.7	Test power: 10% of rated power shall be	Ou ici .∆rvik. vviu iii i ±(2 70+0. 192)
		applied for continuously.	No visible damage
		1	1.10 Tioloid dairiago
		Duration: 1,000 <sup>+48</sup> h	
		Interval measurements: 250 h and 500 h	
4	Operational life	MIL-STD-202 Method 108	RMCH06: $\Delta$ R/R: Within $\pm$ (3%+0.1 $\Omega$ )
	AEC Q200 – No.8	Ambient temperature: 125±2°C	Other: $\Delta$ R/R: Within $\pm$ (2%+0.1 $\Omega$ )
		The applied voltage shall be the voltage to be	
		calculated at 35% of rated dissipation or the limiting element voltage whichever is the	No visible damage
		smaller.	
		Condition: The voltage shall be applied for	
		continuously.	
		Duration: 1000 +48 h	
_	F. 4 1 \ f 1	Interval measurements: 250 h and 500 h	
5	External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking
	AEC Q200 – No.9		and workmanship.
6	Dimensions	JESD22 Method JB-100	As in Table–3
	AEC Q200 – No.10	SESSEE MIGRICA OF 100	/ Sili Iddic O
7	Resistance to Solvents	MIL-STD-202 Method 215	$\Delta$ R/R: Within ±(1%+0.05 $\Omega$ )
	AEC Q200 – No.12	Solvent: 2-propanol at 25°C	/
		Immersion time: 3 min	No visible damage
		Brush: 10 times brushing	_
		Immersion and brush cycle: 3cycle	
8	Mechanical Shock	MIL-STD-202 Method 213	$\Delta$ R/R: Within $\pm$ (0.5%+0.05 $\Omega$ )
	AEC Q200 – No.13	Waveform: half sine,	
		Peak value100G,	No visible damage
		Normal duration 6ms	
		Condition: XX'YY'ZZ', 10times each	

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Table-4(2)

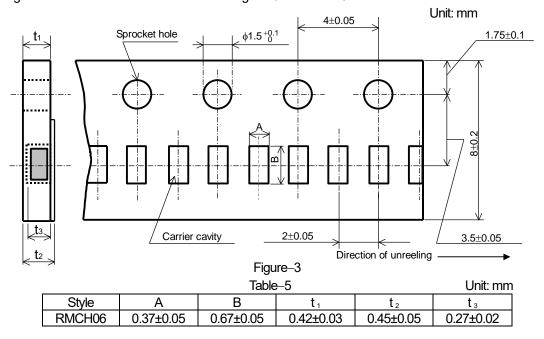
	·	Table 4(2)	
No	Test items	Condition of test	Performance requirements
9	Vibration	MIL-STD-202 Method 204	$\Delta$ R/R: Within $\pm$ (0.5%+0.05 $\Omega$ )
	AEC Q200 – No.14	Peak acceleration and Sweep time: 5 g's for 20	
		min , Frequency 10Hz to 2000Hz,	No visible damage
		Condition: 12 cycles each of 3 orientations	-
10	Resistance to soldering heat	MIL-STD-202 Method 210	$\Delta$ R/R: Within $\pm$ (0.5%+0.05 $\Omega$ )
	AEC Q200 - No.15	Solder bath temp: 260±5°C	
		Immersed time: 10±1s	No visible damage
11	ESD test	AEC-Q200-002	RMCH06: $\Delta$ R/R: Within $\pm$ (5%+0.1 $\Omega$ )
	AEC Q200 – No.17	Human body model, 2 Kohm, 150 pF,	Other:∆R/R: Within ±(1%+0.05Ω)
		Test voltage: RMCH20,32,35: 3000V	
		RMCH16: 2000V	No visible damage
		RMCH10: 800V	
40		RMCH06: 500V	T
12	Solderability	J-STD-002	The surface of terminal immersed
	AEC Q200 – No.18	a) Bake the sample for 155 °C dwell time 4h /	shall be min. of 95% covered with a
		solder dipping 235°C/ 5s. Solder: Sn96.5-Ag3-Cu0.5	new coating of solder.
		b) Category 3, Solder dipping 215°C/5s.	
		Solder: Sn63Pb37	
		c) Category 3, Solder dipping 260°C/7s.	
13	Electrical Characterization	1. D.C. Resistance	1. The resistance value shall
10	AEC Q200 - No.19	Temperature Coefficient of Resistance	correspond with the rated
	7120 Q200 140:10	-55 °C / +20°C	resistance taking into account the
		+20 °C / +155°C	specified tolerance.
			2. As in Table–1
14	Flammability	UL-94	V-0 or V-1 are acceptable
• •	AEC Q200 – No.20		
15	Bending strength	AEC-Q200-005	$\Delta$ R/R: Within $\pm$ (0.5%+0.05 $\Omega$ )
	AEC Q200 – No.21	Bending value2mm	
		Holding time: 60sec.	No visible damage
16	Adhesion	AEC-Q200-006	$\Delta$ R/R: Within ±(0.5%+0.05 $\Omega$ )
	AEC Q200 - No.22	Pressurizing force: RMCH20,32,35: 17.7N	(
		RMCH10,16: 10N	No visible damage
		RMCH06: 3N	
		Test time: 60±1s.	
17	Flame retardance	AEC-Q200-001	The following FAILURE CRITERIA
	AEC Q200 – No.24	Test conditions: 9VDC to 32VDC Each 1h	does not occur.
		This test applies to rated voltages of 32V and	FAILURE CRITERIA
		above.	- Electrically open
			a) A flame over 3.0 seconds duration
			b) An explosion
			c) A temperature above 350°C
			sustained for over 10 s

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#### 8. Taping

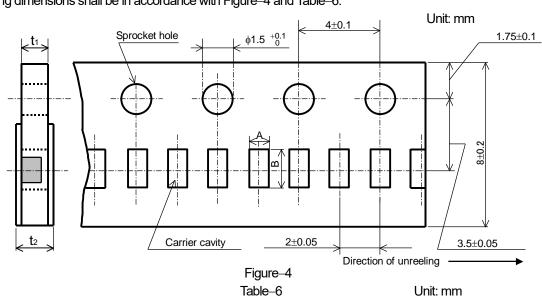
- 8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions
- 8.2.1 Press pocket taping (Paper taping, 8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.



#### 8.2.2 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-4 and Table-6.



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#### 8.2.3 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-5 and Table-7.

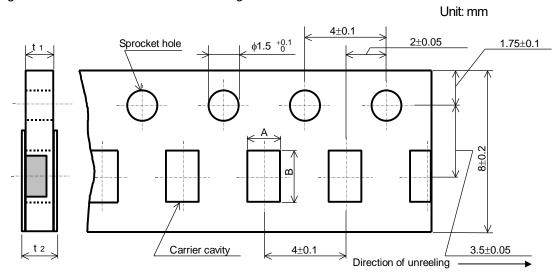


Figure-5

	Unit: mm			
Style	Α	В	<b>t</b> 1	<b>t</b> 2
RMCH16	1.15 ± 0.15	1.9 ± 0.2	0.6 ± 0.1	0.8max.
RMCH20	1.65±0.15	2.5±0.2	0.8±0.1	1.0max.
RMCH32	2.00±0.15	3.6±0.2	U.O±U. I	

# 8.2.3 Embossed taping dimensions shall be in accordance with Figure-6 and Table-8.

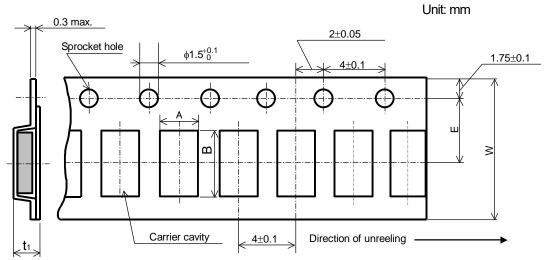


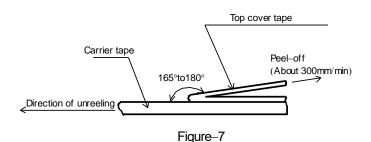
Figure-6

	Unit: mm				
Style	Α	В	W	E	<b>t</b> 1
RMCH35	2.85±0.20	3.5±0.2	8.0±0.3	3.5±0.05	1.0±0.2

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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RMCH06: Figure–7,RMCH10,16,20,32: Figure–8, RMCH35: Figure–9.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

  The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

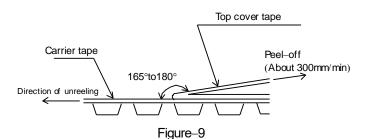


Carrier tape

Peel-off
(About 300mm/min)

Direction of unreeling

Figure-8

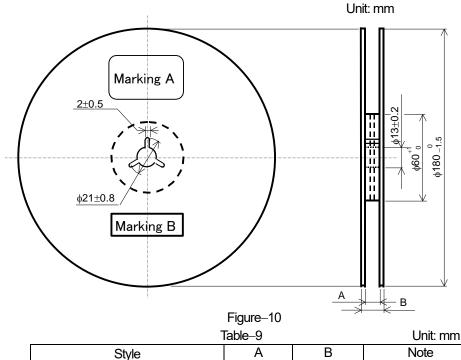


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#### 8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-10 and Table-9.

Plastic reel (Based on EIAJ ET-7200C)

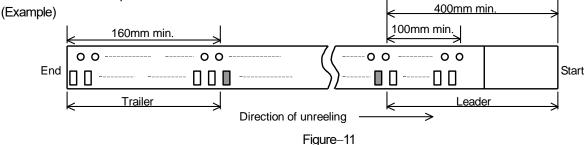


 Style
 A
 B
 Note

 RMCH06,10,16,20,32,35
 9 \*1.0 0 11.4±1.0 Injection molding 13±1.0 Vacuum forming

Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

# 8.4 Leader and trailer tape.



# 9. Marking on package

The label of a minimum package shall be legibly marked with follows.

#### 9.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

9.2 Marking B (KAMAYA Control label)

Issue: KÁMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2024.12.12